INTEGRATED CIRCUITS

DATA SHEET

For a complete data sheet, please also download:

- The IC04 LOCMOS HE4000B Logic Family Specifications HEF, HEC
- The IC04 LOCMOS HE4000B Logic Package Outlines/Information HEF, HEC

HEF4053B
MSI
Triple 2-channel analogue multiplexer/demultiplexer

Product specification
File under Integrated Circuits, IC04

January 1995

Philips Semiconductors

PHILIPS

DESCRIPTION

The HEF4053B is a triple 2-channel analogue multiplexer/demultiplexer with a common enable input ($\overline{E}$). Each multiplexer/demultiplexer has two independent inputs/outputs (Y_0 and Y_1), a common input/output (Z), and select inputs (S_n). Each also contains two-bidirectional analogue switches, each with one side connected to an independent input/output (Y_0 and Y_1) and the other side connected to a common input/output (Z).

With $\overline{E}$ LOW, one of the two switches is selected (low impedance ON-state) by S_n. With $\overline{E}$ HIGH, all switches are in the high impedance OFF-state, independent of S_A to S_C.

V_{DD} and V_{SS} are the supply voltage connections for the digital control inputs (S_A to S_C and $\overline{E}$).
The V_{DD} to V_{SS} range is 3 to 15 V. The analogue inputs/outputs (Y_0, Y_1 and Z) can swing between V_{DD} as a positive limit and V_{EE} as a negative limit. V_{DD}–V_{EE} may not exceed 15 V.

For operation as a digital multiplexer/demultiplexer, V_{EE} is connected to V_{SS} (typically ground).

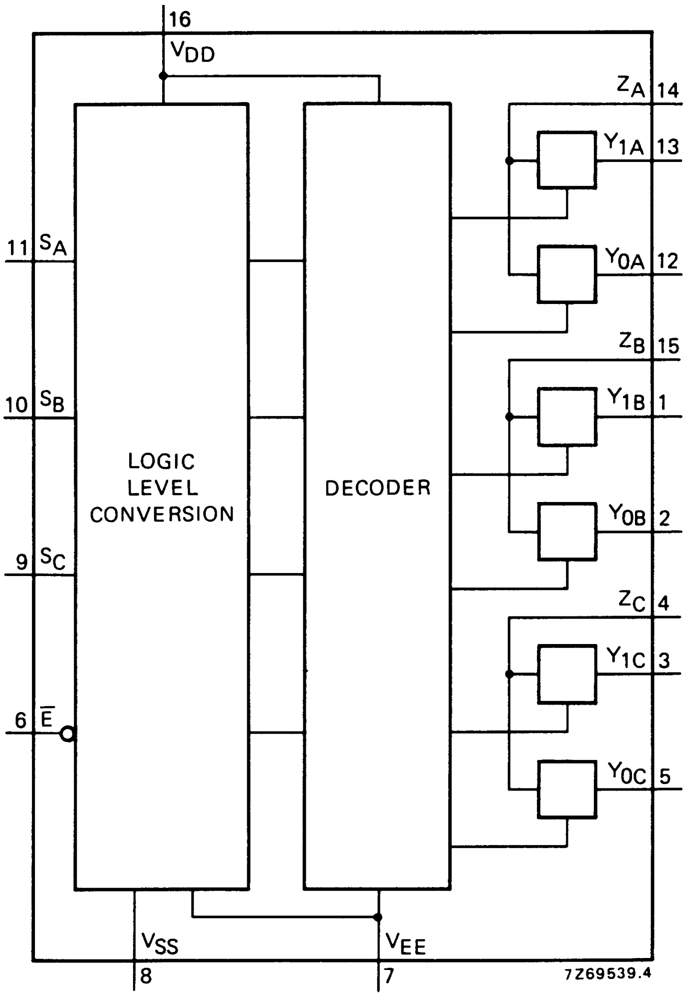


Fig.1 Functional diagram.

FAMILY DATA, I_{DD} LIMITS category MSI

See Family Specifications

Triple 2-channel analogue multiplexer/demultiplexer

HEF4053B
MSI

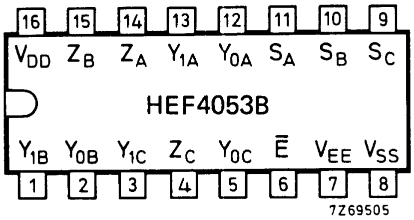


Fig.2 Pinning diagram.

HEF4053BP(N): 16-lead DIL; plastic (SOT38-1)

HEF4053BD(F): 16-lead DIL; ceramic (cerdip) (SOT74)

HEF4053BT(D): 16-lead SO; plastic (SOT109-1)

( ): Package Designator North America

PINNING

Y_{0A} to Y_{0C}	independent inputs/outputs
Y_{1A} to Y_{1C}	independent inputs/outputs
S_A to S_C	select inputs
$\overline{E}$	enable input (active LOW)
Z_A to Z_C	common inputs/outputs

FUNCTION TABLE

INPUTS		CHANNEL ON
$\overline{E}$	S_n	
L	L	Y_{0n}–Z_n
L	H	Y_{1n}–Z_n
H	X	none

Notes

1. H = HIGH state (the more positive voltage)
   L = LOW state (the less positive voltage)
   X = state is immaterial

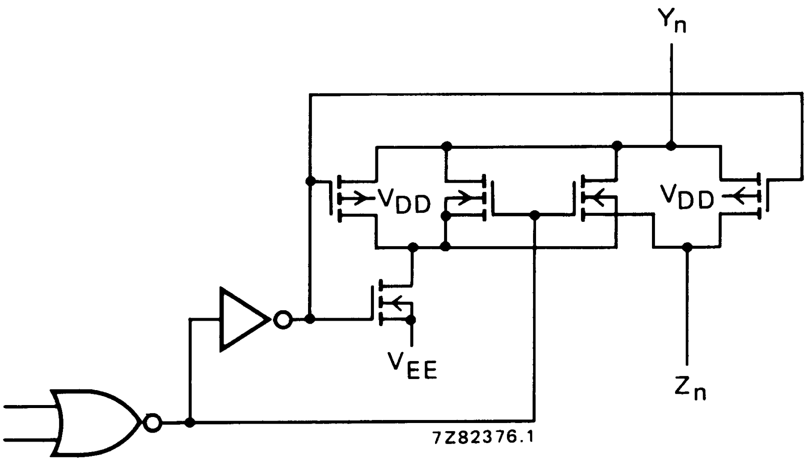


Fig.3 Schematic diagram (one switch).

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

Supply voltage (with reference to V_{DD})	V_{EE}	–18 to + 0,5 V

Note

1. To avoid drawing V_{DD} current out of terminal Z, when switch current flows into terminals Y, the voltage drop across the bidirectional switch must not exceed 0,4 V. If the switch current flows into terminal Z, no V_{DD} current will flow out of terminals Y, in this case there is no limit for the voltage drop across the switch, but the voltages at Y and Z may not exceed V_{DD} or V_{EE}.

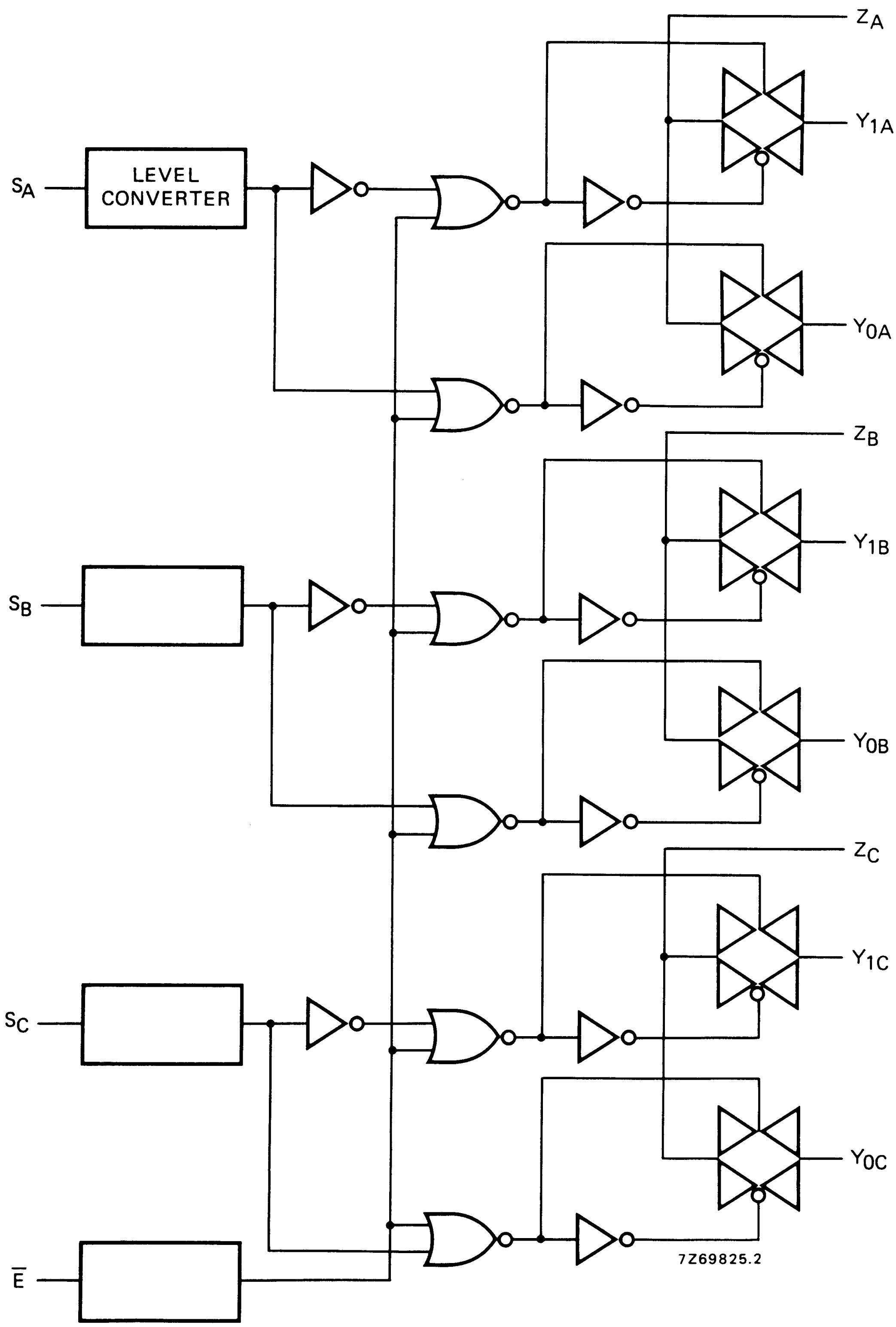


Fig.4 Logic diagram.

DC CHARACTERISTICS

T_{amb} = 25 °C

	$V_{DD}–V_{EE}$ V	SYMBOL	TYP.	MAX.		CONDITIONS
ON resistance	5 10 15	R_{ON}	350 80 60	2500 245 175	Ω Ω Ω	V_{is} = 0 to $V_{DD}–V_{EE}$ see Fig.6
ON resistance	5 10 15	R_{ON}	115 50 40	340 160 115	Ω Ω Ω	V_{is} = 0 see Fig.6
ON resistance	5 10 15	R_{ON}	120 65 50	365 200 155	Ω Ω Ω	V_{is} = $V_{DD}–V_{EE}$ see Fig.6
‘Δ’ ON resistance between any two channels	5 10 15	ΔR_{ON}	25 10 5	– – –	Ω Ω Ω	V_{is} = 0 to $V_{DD}–V_{EE}$ see Fig.6
OFF-state leakage current, all channels OFF	5 10 15	I_{OZZ}	– – –	– – 1000	nA nA nA	$\overline{E}$ at V_{DD}
OFF-state leakage current, any channel	5 10 15	I_{OZY}	– – –	– – 200	nA nA nA	$\overline{E}$ at V_{SS}

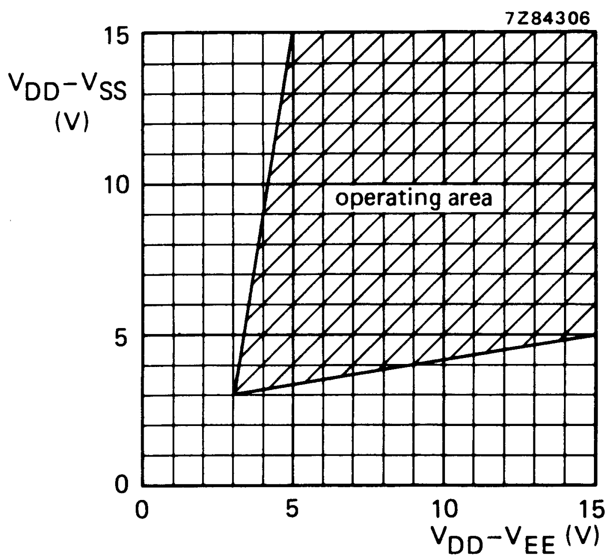


Fig.5 Operating area as a function of the supply voltages.

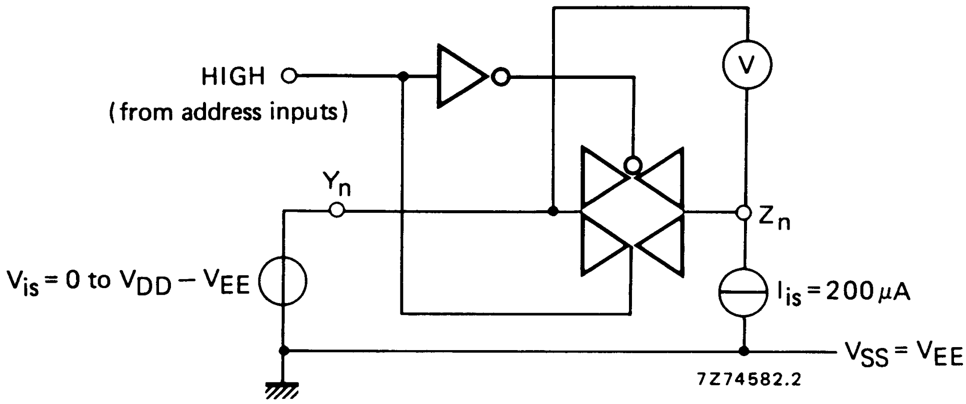
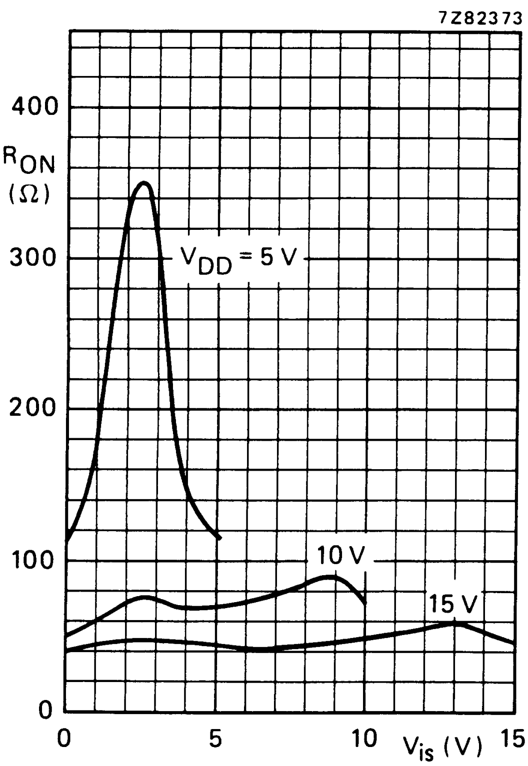


Fig.6 Test set-up for measuring R_{ON}.



I_{is} = 200 μA
$V_{SS} = V_{EE}$ = 0 V

Fig.7 Typical R_{ON} as a function of input voltage.

AC CHARACTERISTICS

$V_{EE} = V_{SS} = 0$ V; $T_{amb} = 25$ °C; input transition times ≤ 20 ns

	V_{DD} V	TYPICAL FORMULA FOR P (μW)	
Dynamic power dissipation per package (P)	5	$2\,500\ f_i + \Sigma(f_oC_L) \times V_{DD}^2$	where
	10	$11\,500\ f_i + \Sigma(f_oC_L) \times V_{DD}^2$	f_i = input freq. (MHz)
	15	$29\,000\ f_i + \Sigma(f_oC_L) \times V_{DD}^2$	f_o = output freq. (MHz)
			C_L = load capacitance (pF)
			$\Sigma(f_oC_L)$ = sum of outputs
			V_{DD} = supply voltage (V)

AC CHARACTERISTICS

$V_{EE} = V_{SS} = 0$ V; $T_{amb} = 25$ °C; input transition times ≤ 20 ns

	V_{DD} V	SYMBOL	TYP.	MAX.		
Propagation delays						
$V_{is} \rightarrow V_{os}$	5		10	20	ns	
HIGH to LOW	10	t_{PHL}	5	10	ns	note 1
	15		5	10	ns	
	5		15	30	ns	
LOW to HIGH	10	t_{PLH}	5	10	ns	note 1
	15		5	10	ns	
$S_n \rightarrow V_{os}$	5		200	400	ns	
HIGH to LOW	10	t_{PHL}	85	170	ns	note 2
	15		65	130	ns	
	5		275	555	ns	
LOW to HIGH	10	t_{PLH}	100	200	ns	note 2
	15		65	130	ns	
Output disable times						
$\overline{E} \rightarrow V_{os}$	5		200	400	ns	
HIGH	10	t_{PHZ}	115	230	ns	note 3
	15		110	220	ns	
	5		200	400	ns	
LOW	10	t_{PLZ}	120	245	ns	note 3
	15		110	215	ns	
Output enable times						
$\overline{E} \rightarrow V_{os}$	5		260	525	ns	
HIGH	10	t_{PZH}	95	190	ns	note 3
	15		65	130	ns	
	5		280	565	ns	
LOW	10	t_{PZL}	105	205	ns	note 3
	15		70	140	ns	

	V_{DD} V	SYMBOL	TYP.	MAX.		
Distortion, sine-wave response	5		0,25		%	
	10		0,04		%	note 4
	15		0,04		%	
Crosstalk between any two channels	5		–		MHz	
	10		1		MHz	note 5
	15		–		MHz	
Crosstalk; enable or address input to output	5		–		mV	
	10		50		mV	note 6
	15		–		mV	
OFF-state feed-through	5		–		MHz	
	10		1		MHz	note 7
	15		–		MHz	
ON-state frequency response	5		13		MHz	
	10		40		MHz	note 8
	15		70		MHz	

Notes

V_{is} is the input voltage at a Y or Z terminal, whichever is assigned as input.

V_{os} is the output voltage at a Y or Z terminal, whichever is assigned as output.

1. R_L = 10 kΩ to V_{EE}; C_L = 50 pF to V_{EE}; $\overline{E}$ = V_{SS}; V_{is} = V_{DD} (square-wave); see Fig.8.
2. R_L = 10 kΩ; C_L = 50 pF to V_{EE}; $\overline{E}$ = V_{SS}; S_n = V_{DD} (square-wave); V_{is} = V_{DD} and R_L to V_{EE} for t_{PLH}; V_{is} = V_{EE} and R_L to V_{DD} for t_{PHL}; see Fig.8.
3. R_L = 10 kΩ; C_L = 50 pF to V_{EE}; $\overline{E}$ = V_{DD} (square-wave);
   V_{is} = V_{DD} and R_L to V_{EE} for t_{PHZ} and t_{PZH};
   V_{is} = V_{EE} and R_L to V_{DD} for t_{PLZ} and t_{PZL}; see Fig.8.
4. R_L = 10 kΩ; C_L = 15 pF; channel ON; V_{is} = ½ $V_{DD\ (p\text{-}p)}$ (sine-wave, symmetrical about ½ V_{DD}); f_{is} = 1 kHz; see Fig.9.
5. R_L = 1 kΩ; V_{is} = ½ $V_{DD\ (p\text{-}p)}$ (sine-wave, symmetrical about ½ V_{DD});

   $$20 \log \frac{V_{os}}{V_{is}} = -50 \text{ dB; see Fig. 10.}$$

6. R_L = 10 kΩ to V_{EE}; C_L = 15 pF to V_{EE}; $\overline{E}$ or S_n = V_{DD} (square-wave); crosstalk is $|V_{os}|$(peak value); see Fig.8.
7. R_L = 1 kΩ; C_L = 5 pF; channel OFF; V_{is} = ½ $V_{DD\ (p\text{-}p)}$ (sine-wave, symmetrical about ½ V_{DD});

   $$20 \log \frac{V_{os}}{V_{is}} = -50 \text{ dB; see Fig. 9.}$$

8. R_L = 1 kΩ; C_L = 5 pF; channel ON; V_{is} = ½ $V_{DD\ (p\text{-}p)}$ (sine-wave, symmetrical about ½ V_{DD});

   $$20 \log \frac{V_{os}}{V_{is}} = -3 \text{ dB; see Fig. 9.}$$

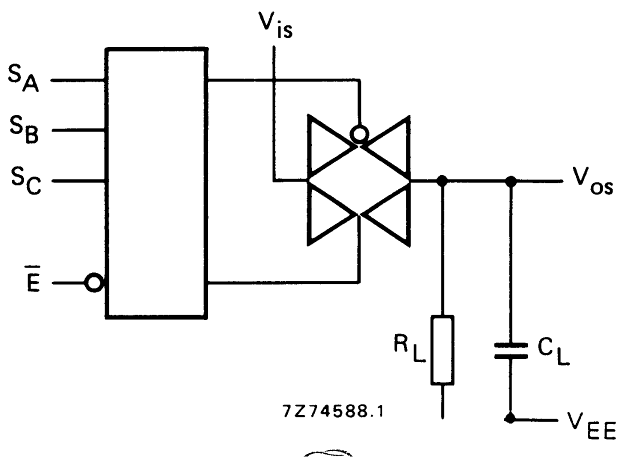


Fig.8

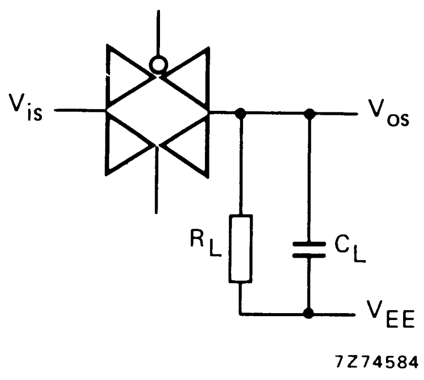


Fig.9

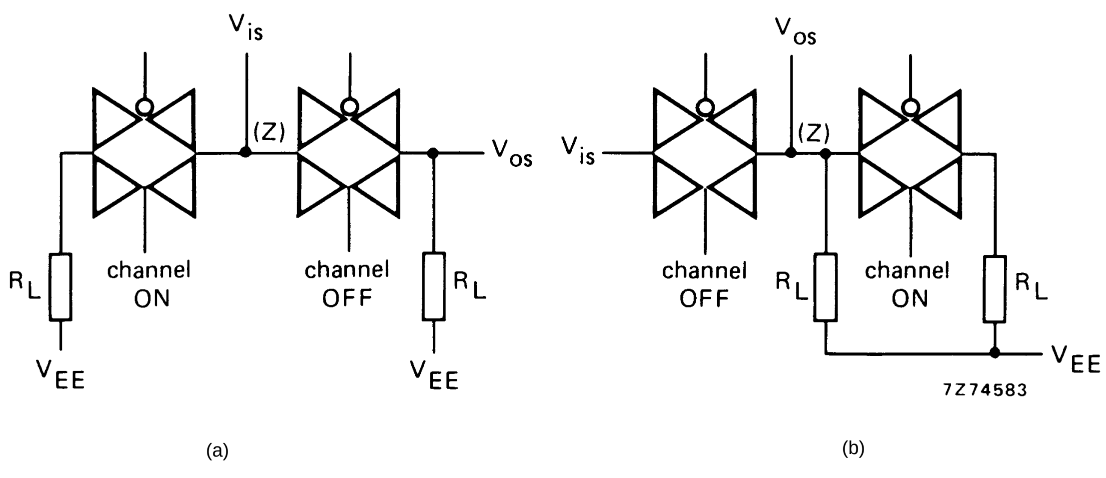


Fig.10

APPLICATION INFORMATION

Some examples of applications for the HEF4053B are:

- Analogue multiplexing and demultiplexing.
- Digital multiplexing and demultiplexing.
- Signal gating.

NOTE

If break before make is needed, then it is necessary to use the enable input.